Memory

Introduction

1. This lesson covers the following:
    - Different types of memory
    - Why memory can't be large, fast, and cheap
    - How memory can store so many bits in a small physical space

How Memory Works

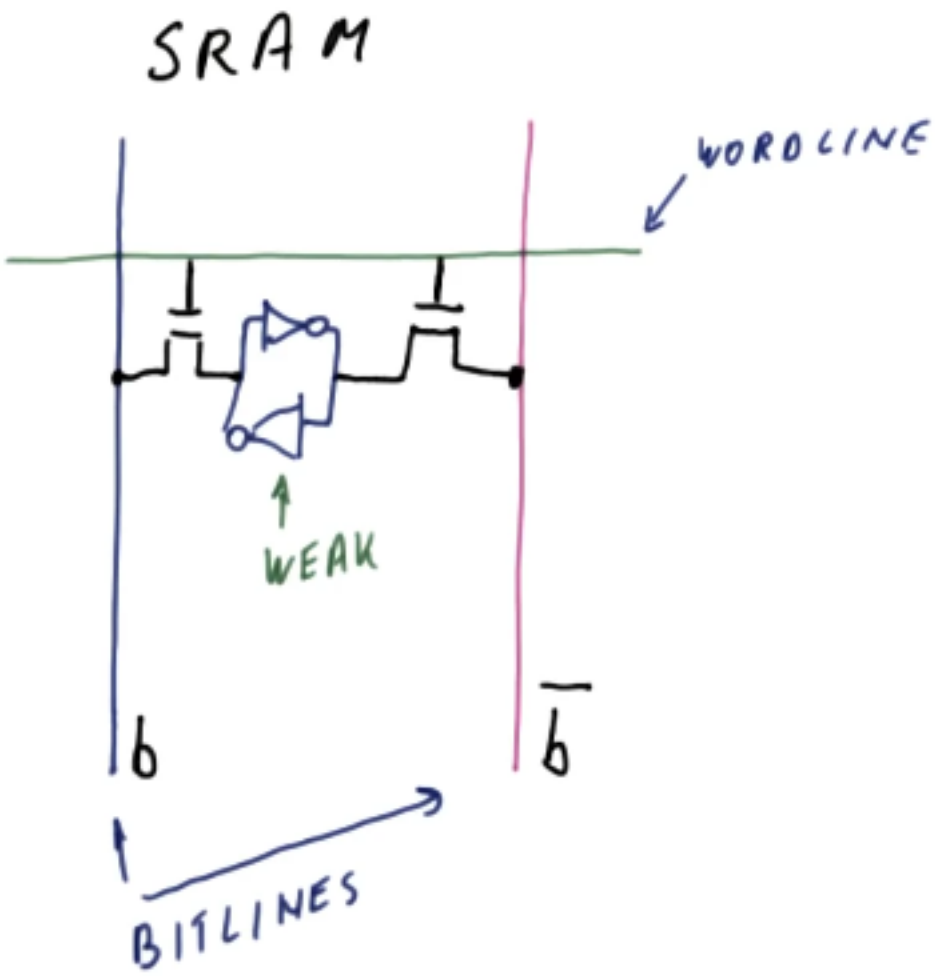
1. Memory technology: SRAM and DRAM
2. Why is memory slow?
3. Why don't we use cache-like memory?
4. What happens when we access main memory?
5. How do we make it faster?

Memory Technology: SRAM and DRAM

1. SRAM: Static Random Access Memory
    - Static: SRAM retains data while power is supplied
    - Requires several transistors per bit
    - Typically faster
2. DRAM: Dynamic Random Access Memory
    - Dynamic: DRAM will lose data if we don't refresh it
    - Only requires one transistor per bit
    - Typically slower
3. Random access: Can access any memory location without going through all memory locations
    - As opposed to sequential access like a tape
4. SRAM and DRAM will lose data when power is not supplied

One Memory Bit SRAM

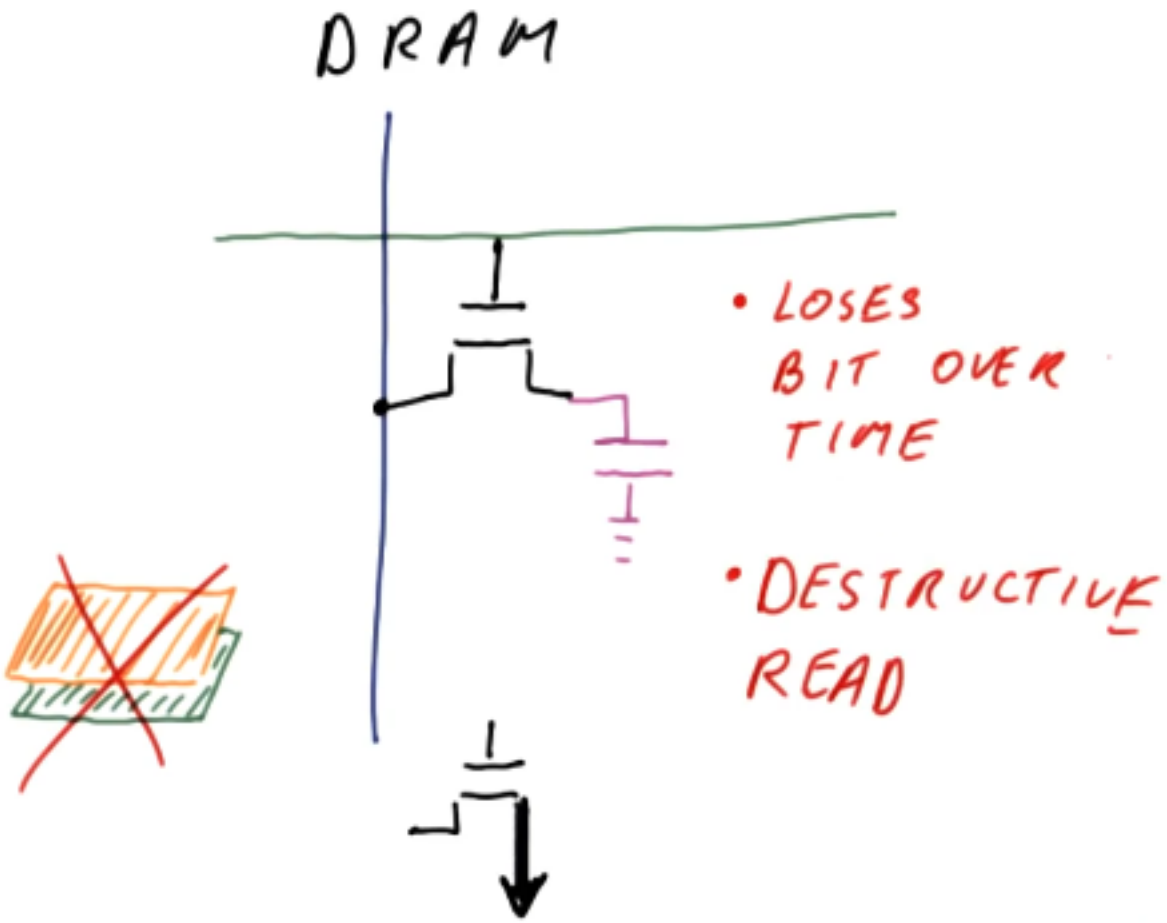
1. Memory works by manipulating a wordline and bitline to read/write to an array of transistors
2. In SRAM, each cell has a double inverter (one inverter requires two transistors)
    - This feedback loop is what makes the memory static
    - The voltage output by the transistor is greater than the voltage output by the inverter loop, so they are easy to overwrite
    - Typically connect the inverters to two bit lines with a transistor in between each
        - Allows us to more easily detect changes because we can observe the difference in voltage between the two bitlines
3. SRAM is a 6T cell (6 transistors)



One Bit Memory SRAM

One Memory Bit DRAM

1. Implemented with a single capacitor
   - When we activate the bitline, the capacitor is charged with a 1
   - When we deactivate the bitline, the capacitor is discharged to a 0
2. Transistor is not a perfect switch, it's a little bit leaky
   - In SRAM, the inverter loop keeps the charge
   - In DRAM, the capacitor loses charge, so we need to periodically refresh it
3. Destructive read: Opening the wordline to read the value causes the capacitor to lose some charge
   - When we perform a read, we also need to recharge the capacitor
4. DRAM is a 1T cell (1 transistor)
5. Area of a DRAM cell is area of transistor plus area of capacitor
   - Bigger capacitors allow for the charge to be maintained longer
   - Capacitor is buried beneath the silicon, so the effective area is the area of the transistor ("trench cell")
   - DRAM also only requires one bitline



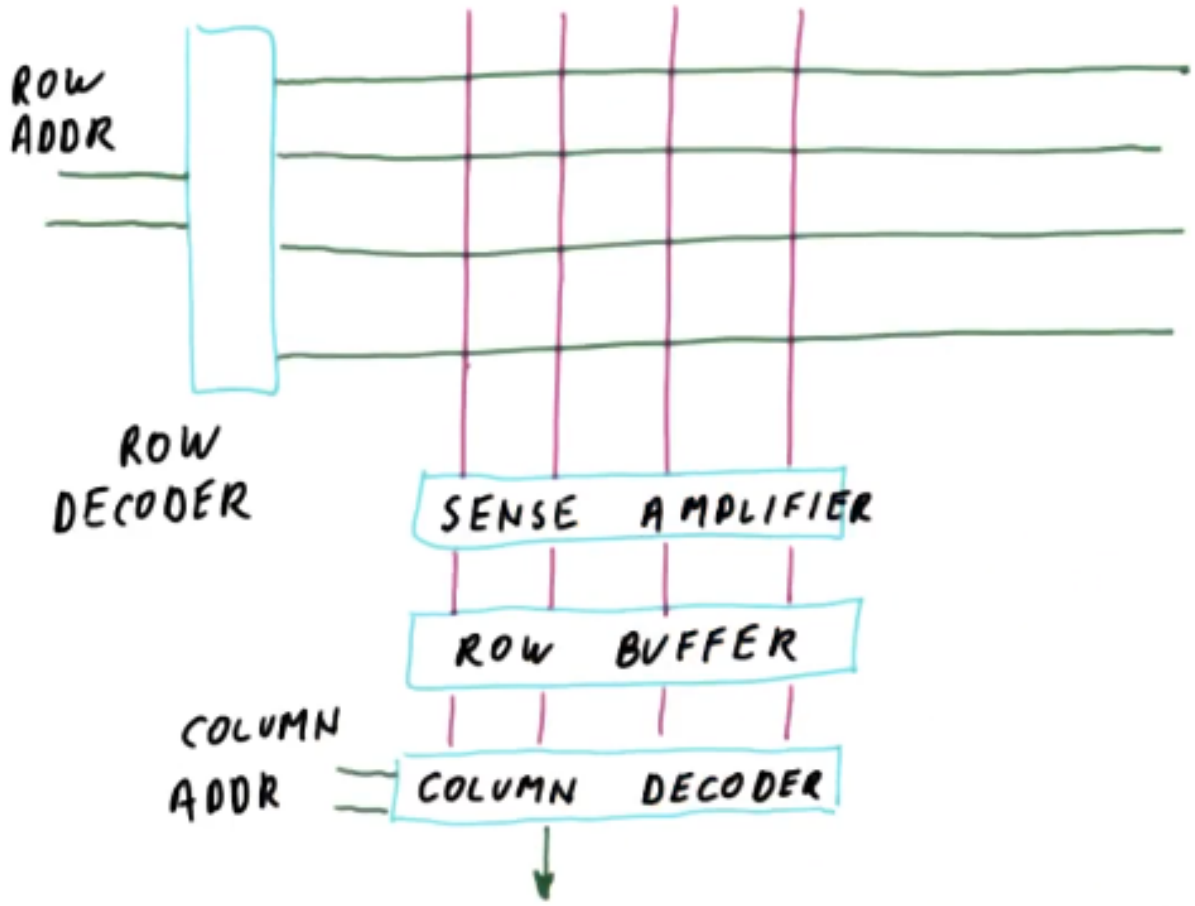
One Bit Memory DRAM

DRAM Technology Quiz

1. What not use a "normal" transistor and a capacitor when making DRAM?
   - Trench cell is easier to make (false)
   - Trench cell is more reliable (false)
   - Trench cell lets us make cheaper DRAM chips (true)

Memory Chip Organization Part 1

1. Row decoder takes a row address and determines which wordline to read
   - Detects multiple cells to the bitline
2. Bitlines are connected to a sense amplifier
   - Helps the cell raise or lower the voltage on a bitline
   - Only need one at end of bitline, not one per cell
3. Output of sense amplifier goes to a row buffer
4. Row buffer goes to column decoder
   - Column address is input to the column decoder to pick one bit from the row
5. If we want to be able to read more than one bit at a time, we replicate this structure



Memory Organization

Memory Chip Organization Part 2

1. After the bit is read, the sense amplifier is reversed to write the values back
   - This is due to the fact that reads to DRAM are destructive
2. DRAM is slower for two reasons
   - Destructive read requires writing the value back (read-then-write)
   - Cell does not pull the bitline as strongly, so the sense amplifier needs more time to determine the correct value
3. Refresh: Make sure each row is read at some regular interval
   - Refresh row counter: Iterates through the rows reading-then-writing each
   - Refresh period T (typically less than a second)
   - N rows (modern memory has large N)

Memory Refresh Quiz

1. Consider memory with the following parameters: *4096 rows, 2048 columns
   - Refresh period is 500 microseconds
2. Read timing:
   - 4 ns to select a row
   - 10 ns for sense amplifier to get bit values

- 2 ns to put data in row buffer
- 4 ns for column decoder
- 11 ns to write data from sense amplifier to memory row
  - This is overlapped with putting data in row buffer and decoding

3. How many reads per second can this memory support?
   - Read takes 4 + 10 + max(2 + 6, 11) = 25 ns -> 40 M refreshes per second
   - Refresh period is 500 microseconds, so we need to do 2000 refreshes per second
   - Refreshes per second = 2000 * 4096 = 8.192 M refreshes per second
   - Total reads = 40M - 8.192M = 31808000

Memory Chip Organization Part 3

1. How do we write to memory?
   - Use the row address to select a row
   - Read all of the bits in the row and latch into the row buffer
   - Use the column decoder to select the correct bitline
   - Write the value to the row buffer
   - When the sense amplifier writes the data back, the memory will store the correct value
2. Write is a "read-then-write" operation

Fast Page Mode

1. Once a word is read into the row buffer, we can read data directly from the row buffer instead of re-opening the page
2. Opening a page:
   - Row address
   - Select row
   - Sense amplifier
   - Latch into row buffer
3. Read/write
   - Reading and writing only modifies the row buffer
   - Can do this many times without having to close/reopen the page
4. Closing the page:
   - Write data from row buffer back to memory row

DRAM Access Scheduling Quiz

1. DRAM has 32 1-bit arrays
2. Each array is 16 megabit array (2 ^ 12 rows * 2 ^ 12 bits per row)
3. Assume the following:
   - Page open: 10 ns
   - Read from row buffer: 2 ns
   - Page close: 5 ns
4. Consider the following set of memory accesses:
   - F00F00
   - E00F00
   - F00E04
   - E04F00
   - E00E00
   - F00123
   - 123F00
   - The upper three hex digits are the row address, the lower three are the column address
5. How long do these memory accesses take in the current order?
   - F00F00 (10 + 2 + 5 = 17)

- E00F00 (10 + 2 + 5 = 17)
- F00E04 (10 + 2 + 5 = 17)
- E04F00 (10 + 2 + 5 = 17)
- E00E00 (10 + 2 + 5 = 17)
- F00123 (10 + 2 + 5 = 17)
- 123F00 (10 + 2 + 5 = 17)
- 17 * 7 = 119 ns

6. How long do these memory accesses take in the optimal reordering?
   - F00F00 (10 + 2 = 12)
   - F00E04 (2)
   - F00123 (2 + 5 = 7)
   - E00E00 (10 + 2 = 12)
   - E00F00 (2 + 5 = 7)
   - E04F00 (10 + 2 + 5 = 17)
   - 123F00 (10 + 2 + 5 = 17)
   - Total = 12 + 2 + 7 + 12 + 7 + 17 + 17 = 74

Connecting DRAM to the Processor

1. Want to be able to connect multiple memory chips to the same processor
   - Add a memory controller between the front-side bus and DRAM that connects the LLC to the memory
   - Memory channel connects memory controller to DRAM
2. Total memory latency includes the following:
   - Sending request to memory controller, its
   - Memory controller logic
   - Sending the data over the memory channel
   - Memory latency
   - Sending the data back over the memory channel
   - Sending the data back to the processor from the memory controller
3. Recent processor integrate the memory controller into the same chip as the processor and caches
   - Eliminates the need for the front-side bus to reduce latency (10-30%)
   - This means the processor is designed to work with a specific type of DRAM
     - Required standardizing memory construction

Conclusion

1. Examined how DRAM and SRAM works
2. Will examine disk drives which have a lower cost per bit but are much slower